

BB305C

Build in Biasing Circuit MOS FET IC UHF/VHF RF Amplifier

HITACHI

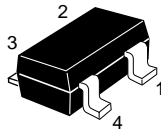
ADE-208-608C (Z)
4th. Edition
May 1998

Features

- Build in Biasing Circuit; To reduce using parts cost & PC board space.
- Superior cross modulation characteristics.
- High gain; (PG = 28 dB typ. at $f = 200$ MHz)
- Wide supply voltage range;
Applicable with 5 V to 9 V supply voltage.
- Withstanding to ESD;
Build in ESD absorbing diode. Withstand up to 200V at $C = 200$ pF, $R_s = 0$ conditions.
- Provide mini mold packages; CMPAK-4 (SOT-343mod)

Outline

CMPAK-4



1. Source
2. Gate1
3. Gate2
4. Drain

- Note: 1. Marking is "EW-".
2. BB305C is individual type number of HITACHI BBFET.

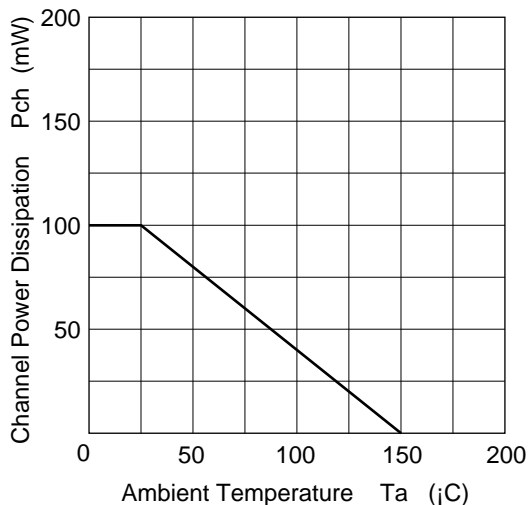
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DS}	12	V
Gate1 to source voltage	V_{G1S}	+10 -0	V
Gate2 to source voltage	V_{G2S}	+10	V
Drain current	I_D	25	mA
Channel power dissipation	Pch	100	mW
Channel temperature	Tch	150	$^\circ\text{C}$
Storage temperature	Tstg	-55 to +150	$^\circ\text{C}$

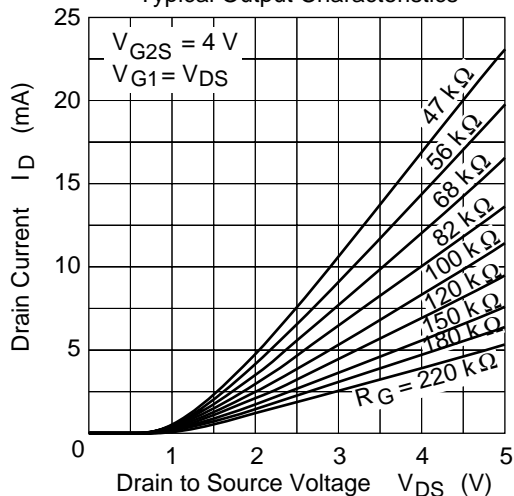
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	12	—	—	V	$I_D = 200\mu A, V_{G1S} = V_{G2S} = 0$
Gate1 to source breakdown voltage	$V_{(BR)G1SS}$	+10	—	—	V	$I_{G1} = +10\mu A, V_{G2S} = V_{DS} = 0$
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	± 10	—	—	V	$I_{G2} = \pm 10\mu A, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff current	I_{G1SS}	—	—	+100	nA	$V_{G1S} = +9V, V_{G2S} = V_{DS} = 0$
Gate2 to source cutoff current	I_{G2SS}	—	—	± 100	nA	$V_{G2S} = \pm 9V, V_{G1S} = V_{DS} = 0$
Gate1 to source cutoff voltage	$V_{G1S(off)}$	0.4	—	1.0	V	$V_{DS} = 5V, V_{G2S} = 4V, I_D = 100\mu A$
Gate2 to source cutoff voltage	$V_{G2S(off)}$	0.4	—	1.0	V	$V_{DS} = 5V, V_{G1S} = 5V, I_D = 100\mu A$
Input capacitance	C_{iss}	2.3	2.8	3.5	pF	$V_{DS} = 5V, V_{G1} = 5V$
Output capacitance	C_{oss}	1.1	1.5	1.9	pF	$V_{G2S} = 4V, R_G = 82k\Omega$
Reverse transfer capacitance	C_{rss}	—	0.017	0.04	pF	$f = 1MHz$
Drain current	$I_{D(op)1}$	10	15	20	mA	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V, R_G = 82k\Omega$
	$I_{D(op)2}$	—	13	—	mA	$V_{DS} = 9V, V_{G1} = 9V, V_{G2S} = 6V, R_G = 220k\Omega$
Forward transfer admittance	$ y_{fs} 1$	23	28	—	mS	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V, R_G = 82k\Omega, f = 1kHz$
	$ y_{fs} 2$	—	28	—	mS	$V_{DS} = 9V, V_{G1} = 9V, V_{G2S} = 6V, R_G = 220k\Omega, f = 1kHz$
Power gain	PG1	24	28	—	dB	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V, R_G = 82k\Omega, f = 200MHz$
	PG2	—	28	—	dB	$V_{DS} = 9V, V_{G1} = 9V, V_{G2S} = 6V, R_G = 220k\Omega, f = 200MHz$
Noise figure	NF1	—	1.3	1.8	dB	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V, R_G = 82k\Omega, f = 200MHz$
	NF2	—	1.3	—	dB	$V_{DS} = 9V, V_{G1} = 9V, V_{G2S} = 6V, R_G = 220k\Omega, f = 200MHz$

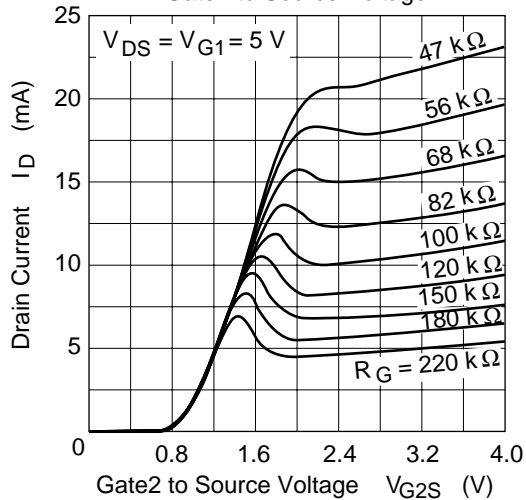
Maximum Channel Power Dissipation Curve



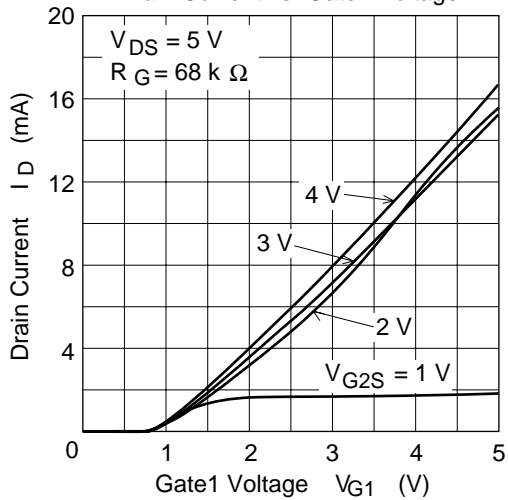
Typical Output Characteristics

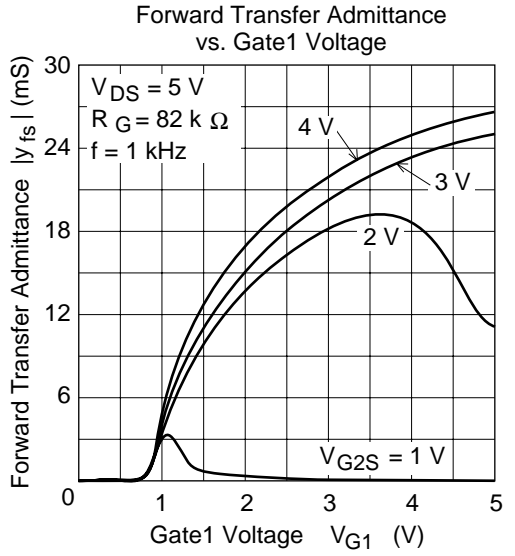
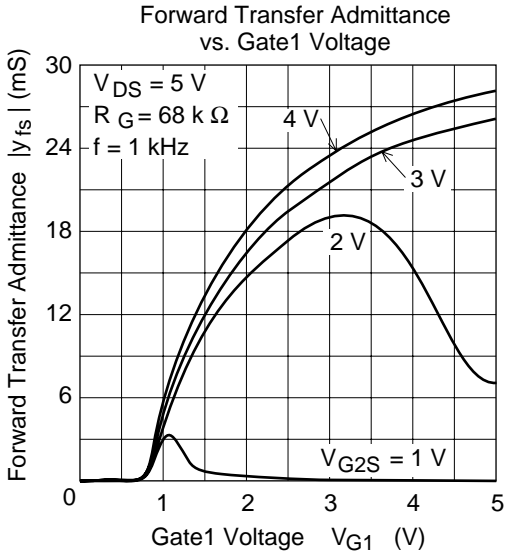
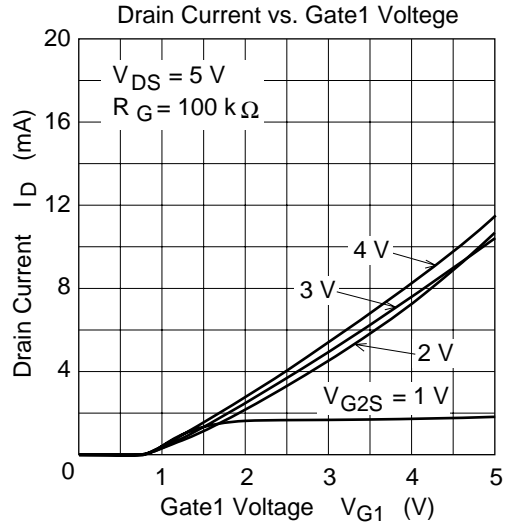
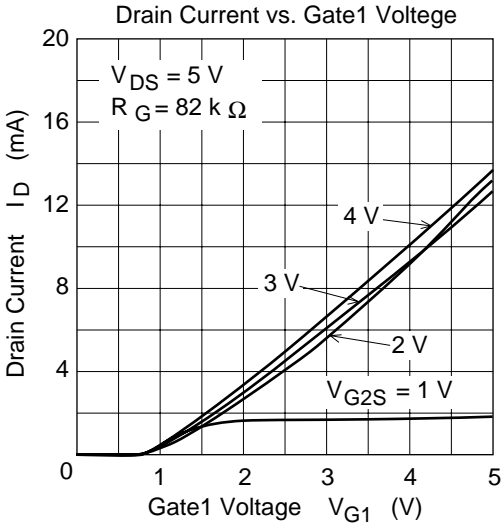


Drain Current vs. Gate2 to Source Voltage

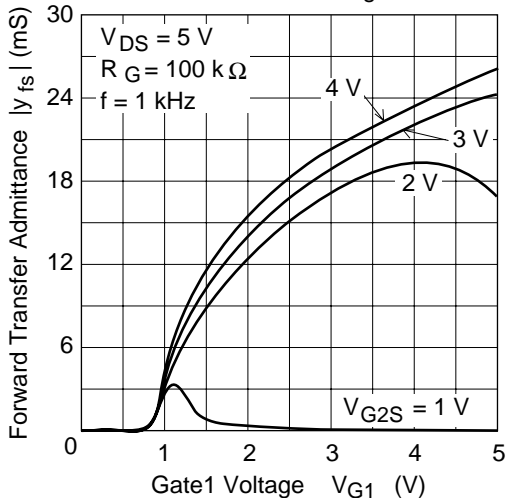


Drain Current vs. Gate1 Voltage

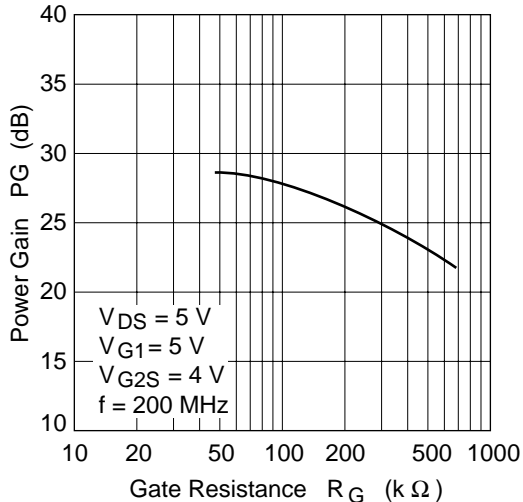




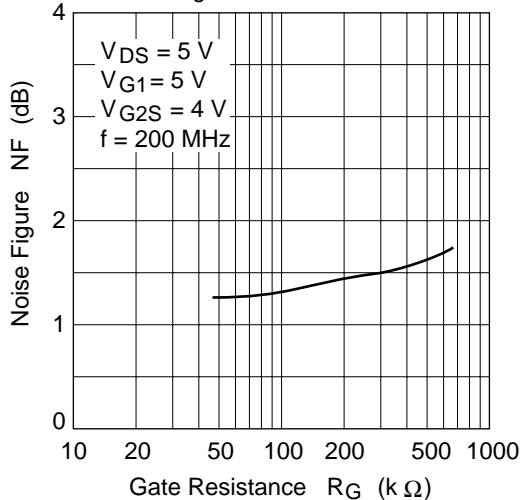
Forward Transfer Admittance vs. Gate1 Voltage



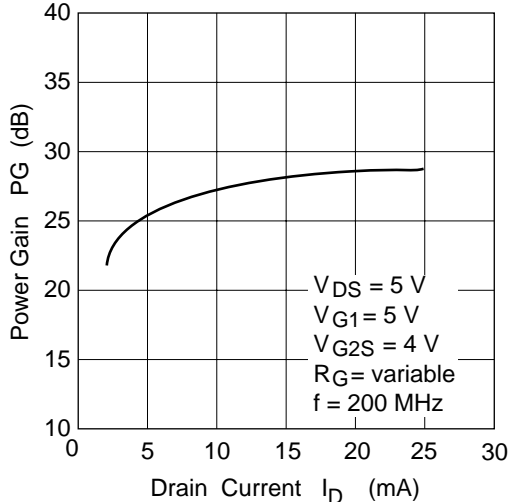
Power Gain vs. Gate Resistance

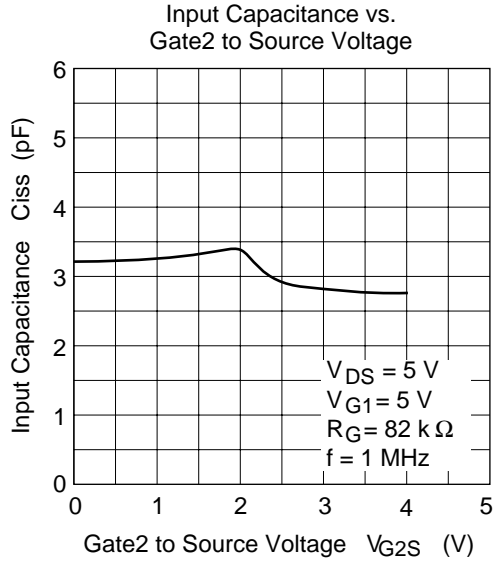
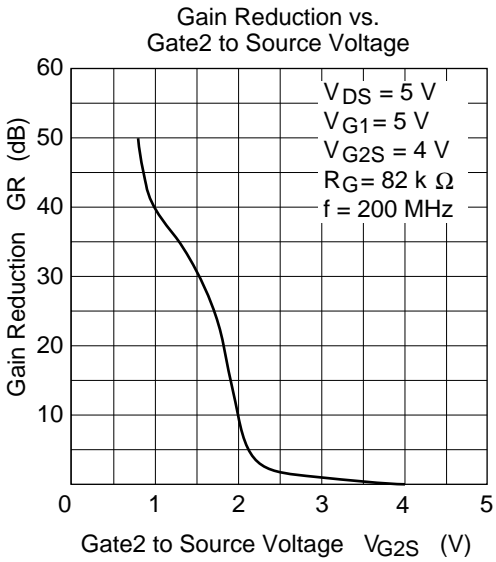
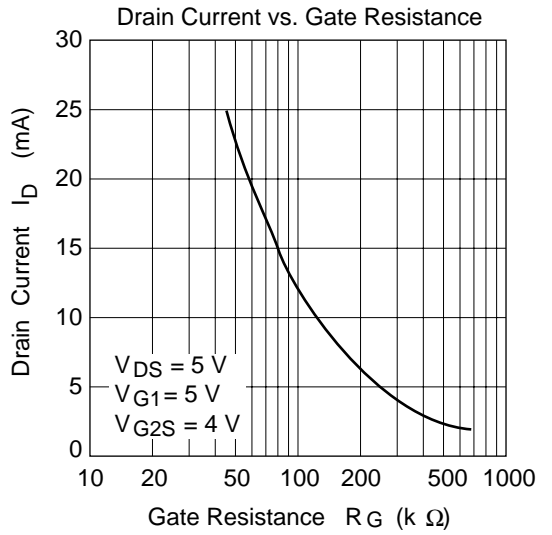
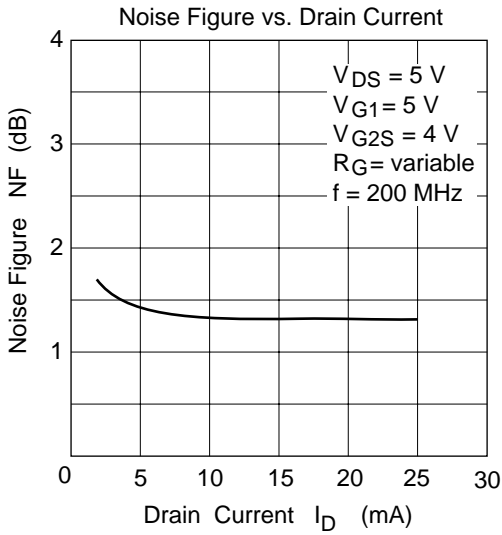


Noise Figure vs. Gate Resistance

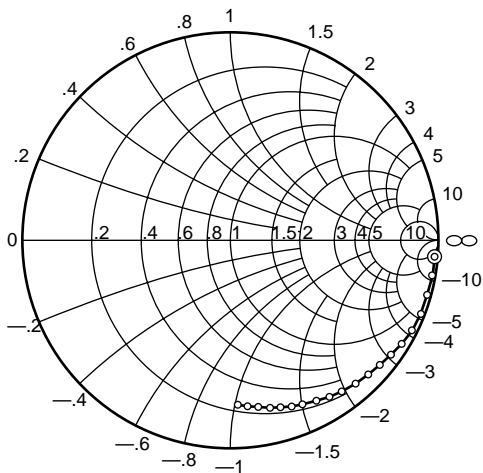


Power Gain vs. Drain Current





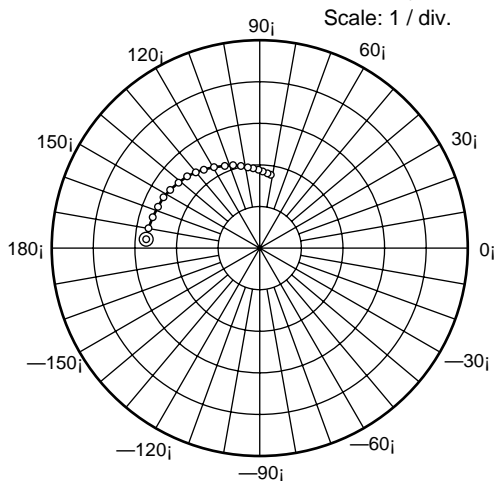
S11 Parameter vs. Frequency



Test Condition : $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 50 1000 MHz (50 MHz step)

⊙—○

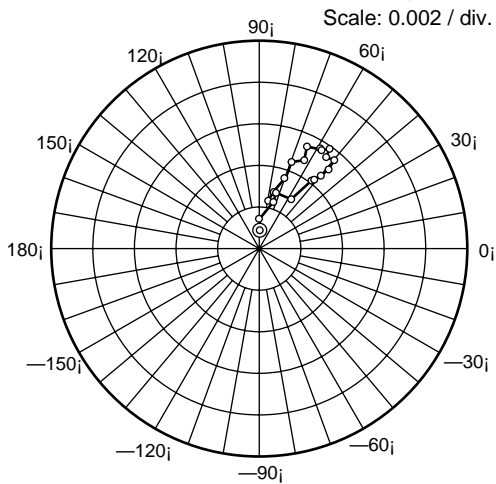
S21 Parameter vs. Frequency



Test Condition : $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 50 1000 MHz (50 MHz step)

⊙—○

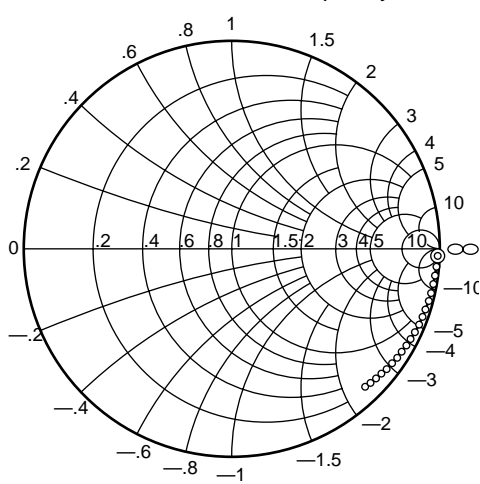
S12 Parameter vs. Frequency



Test Condition : $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 50 1000 MHz (50 MHz step)

⊙—○

S22 Parameter vs. Frequency



Test Condition : $V_{DS} = 5\text{ V}$, $V_{G1} = 5\text{ V}$
 $V_{G2S} = 4\text{ V}$, $R_G = 82\text{ k}\Omega$
 50 1000 MHz (50 MHz step)

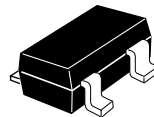
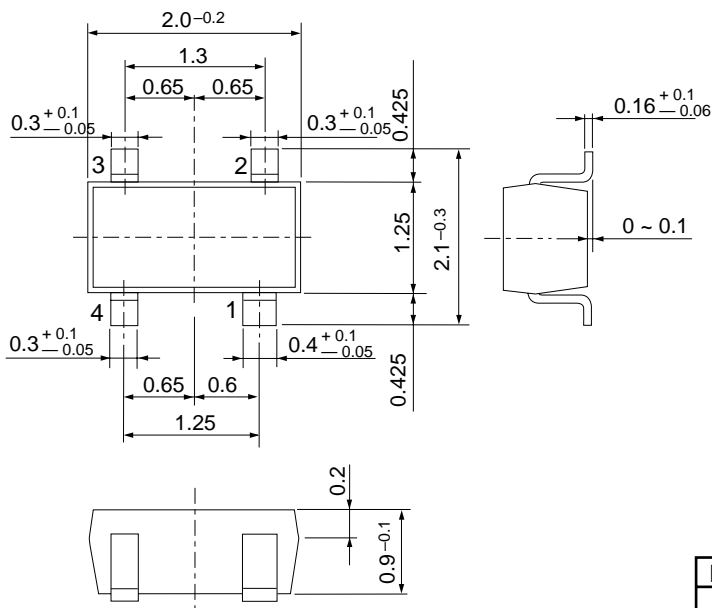
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Sparameter ($V_{DS} = V_{G1} = 5V$, $V_{G2S} = 4V$, $R_G = 82k\Omega$, $Z_0 = 50\Omega$)

f (MHz)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
50	0.991	-4.8	2.69	174.9	0.00090	91.4	0.991	-2.2
100	0.991	-9.9	2.68	169.3	0.00153	90.5	0.992	-4.8
150	0.982	-15.4	2.66	163.4	0.00243	73.8	0.991	-7.5
200	0.975	-20.7	2.62	157.5	0.00293	74.9	0.989	-9.9
250	0.972	-25.6	2.60	152.0	0.00370	70.1	0.985	-12.6
300	0.956	-30.6	2.54	146.3	0.00444	69.0	0.981	-15.0
350	0.942	-35.5	2.47	140.9	0.00478	63.7	0.977	-17.3
400	0.928	-40.1	2.42	135.7	0.00535	64.8	0.973	-19.7
450	0.920	-44.9	2.38	130.5	0.00551	56.8	0.967	-22.0
500	0.906	-49.2	2.32	125.7	0.00549	58.6	0.962	-24.5
550	0.894	-53.6	2.25	120.8	0.00584	54.4	0.957	-26.9
600	0.880	-57.8	2.18	116.2	0.00542	53.3	0.952	-29.2
650	0.868	-62.1	2.12	111.5	0.00562	49.5	0.944	-31.5
700	0.854	-66.2	2.06	106.8	0.00509	48.6	0.939	-33.8
750	0.842	-70.3	2.00	102.5	0.00465	49.7	0.933	-36.1
800	0.835	-73.9	1.94	98.4	0.00427	51.6	0.927	-38.3
850	0.820	-77.7	1.89	94.0	0.00416	53.3	0.921	-40.5
900	0.802	-81.5	1.83	89.6	0.00289	57.9	0.915	-42.7
950	0.801	-84.7	1.78	85.6	0.00288	72.9	0.909	-44.9
1000	0.789	-87.9	1.73	82.1	0.00241	78.9	0.904	-47.1

Package Dimensions

Unit: mm



Hitachi Code	CMPAK-4
EIAJ	SC-82AB
JEDEC	

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL North America : <http://semiconductor.hitachi.com/>
 Europe : <http://www.hitachi-eu.com/hel/ecg>
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building, No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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